1 PCB Layout Guidelines

- Ensure that power bus/plane routing is adequate to handle current requirements of device.
  - 1.1VD and 1.8VA are the highest current supplies.
    - The typical current for 1.8VA is approximately 170 mA.
    - The typical current for 1.1VD is approximately 156 mA.
  - The typical current of 3.3VD is approximately 40 mA.
  - The typical current of 1.1VA is approximately 20 mA.
  - The typical current of 3.3VA is approximately 5 mA.

Note: Typical current numbers are based on 4-CH D1 mode at 108 MHz.

- Place TVP5158 as close as possible to the video/audio input jack.
- All device decoupling capacitors should be placed near the power and GND pins of the device.
- Keep reasonable clearances between the 27-MHz crystal/associated circuitry and adjacent audio/video trace routing. Reasonable clearances of eight to ten times the associated trace width, ground shields placed around audio/video traces, and placing a cutout in the ground plane and ground fill layers around the 27-MHz crystal and associated circuitry all help isolate the crystal input.
- XTAL_REF input, pin 100, should be connected directly to crystal load capacitors. A 0-Ω resistor to analog ground, VSSA, should be added to XTAL_REF input/crystal load capacitor junction to provide flexibility to the crystal reference connection.
- All audio and video input traces should have a minimum clearance of ten times the trace width between each other and other adjacent traces to minimize potential crosstalk between inputs.
- VIN_x_P and VIN_x_N should be routed side by side as differential lines. The clearance between two traces should two to three times the trace width.
- Maintain a CVBS video input trace impedance of 75 Ω.
- Maintain reasonable routing clearance (six to eight times trace width) between the digital video bus/clock and the digital audio bus routing.
- SDA/SCL traces should be routed together and have a minimum clearance of ten times the trace width from any adjacent traces.
- Digital video output traces, including clocks to the input of DSP and other backend processors, should be line-length matched. This is particularly important when the maximum data rate of 108 MHz is used.
- Digital video output traces, including the clock, should be less than six inches long between TVP5158 and backend processors, such as TI DaVinci™ HD.
  - Maximum specified loading is 10 pF for data rates equal to or lower than 81 MHz.
  - Maximum specified loading is 6 pF for data rates of 108 MHz.
  - Minimize vias in digital video/clock bus routing between TVP5158 and backend processors.
  - 10-Ω to 22-Ω series termination in the clock line is recommended.
- Digital video output traces should be line-length matched. (The maximum data rate of cascade input is 54 MHz.)
- All high-speed signals routed on the bottom of the board should be routed over solid power/ground planes and not routed over power/ground splits. Route signals over their associated power/ground plane where possible.
- Use ground fills on the top and bottom of the board for additional signal isolation.
• Tie the TVP5158 exposed thermal pad to the digital ground plane if using a split ground plane approach for board layout. A split ground plane is preferred but is not a requirement.
• If a split ground plane (AGND/DGND) approach is used for board layout, Figure 1 shows the recommendation for the split relative to device pins and the package thermal pad.

Figure 1.
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